

Thermal characterization of Polylactic Acid by Thermal Analysis

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Introduction

Biodegradable plastic has gained attention in recent years due to concerns about waste disposal and environmental conservation. Polylactic acid (PLA) is a biodegradable plastic derived from plants and continues to be widely used in packing, fibers and medical materials. Crystallinity is an important consideration for the strength, impact resistance, and transparency requirements of these products and also influences biodegradability. Furthermore, lactic acid, the PLA monomer, has asymmetrical carbon and thus optical isomers. The isomer ratio and molecular weight of polymers influence crystallinity and heat resistance, so they are factors in the molding process.

In this paper, the crystallinity and heat resistance of polylactic acid are evaluated using DSC and TG. Three samples had roughly the same molecular weight but different optical isomer L-form/D-form ratios and two samples had the same L-form/D-form ratio but different molecular weights.

Experiment Sample 1: Polylactic acid; a, b, c and c' L-form ratio; a < b < c = c' Molecular weight; a = b = c > c' Instrument:

DSC6220 and TG/DTA6200

(SII NanoTechnology Inc.)

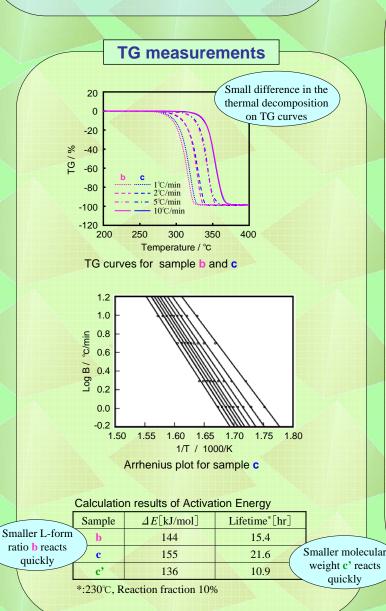
Measurement Condition:

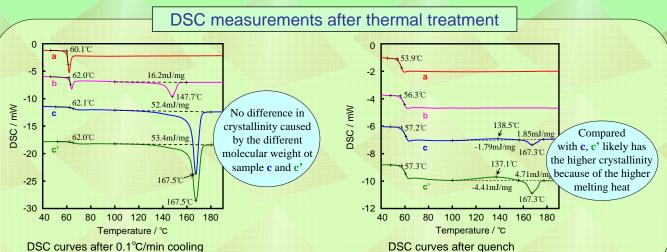
DSC measurements

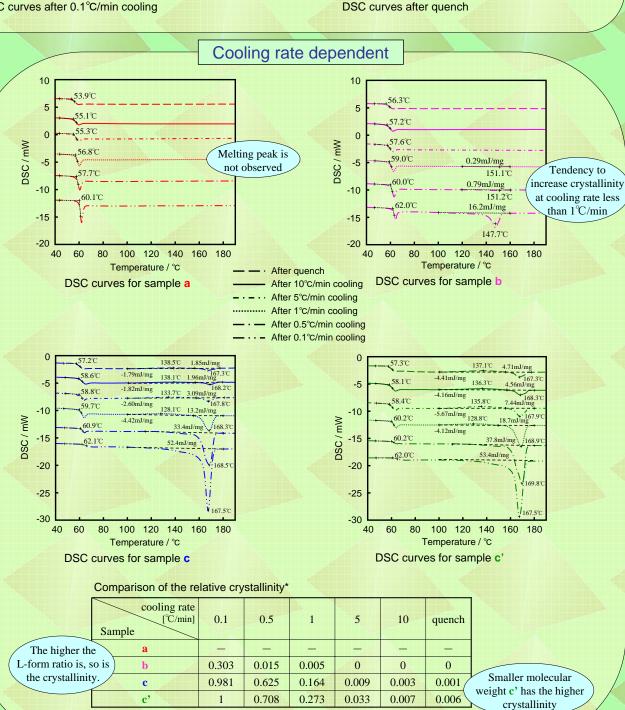
Samples were heated to 200°C and then cooled at various rates (quench, 10, 5, 1, 0.5 and 0.1°C/min). The samples were then heated from 20°C to 200°C at 10° C/min in N_2 atmosphere.

TG measurements

Samples were prepared without any thermal treatments, but simply heated from room temperature to 400°C at rates of 10, 5, 2 or 1°C/ min.







*: Sample c' melting heat (after 0.1°C/min cooling) is set as 1

Conclusion

Crystallinity and heat resistance are important factors in PLA plastic molding. This study shows that DSC can be used to learn about crystallinity and the validity of crystallization conditions. Furthermore, thermal decomposition measurements TGA were able to evaluate heat resistance at molding temperatures.